















**ESD** 

TVS

MOS

LDO

Diode

Sensor

DC-DC

# **Product Specification**

Domestic Part Number	MB05M THRU MB10M
Overseas Part Number	MB05M THRU MB10M
▶ Equivalent Part Number	MB05M THRU MB10M





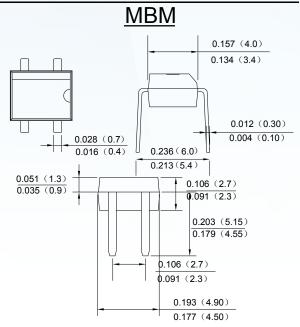
#### SINGLE PHASE 0.8AMP GLASS PASSIVATED BRIDGE RECTIFIER

#### **Features**

- Glass passivated die construction
- Low forward voltage drop
- · High current capability
- High surge current capability
- Plastic material-UL flammability 94V-0

#### **Mechanical Data**

- Case: MB-M, molded plastic
- Terminals: plated leads solderable per MIL-STD-202, Method 208
- · Polarity: as marked on case
- Mounting position: Any
- Marking: type number
- · Lead Free: For RoHS / Lead Free Version,



Dimiensions in inches and (milimeters)

### **Maximum Ratings and Electrical Characteristics**

Rating at 25°C ambient temperature unless otherwise specified.

Single Phase, half wave, 60Hz, resistive or inductive load.

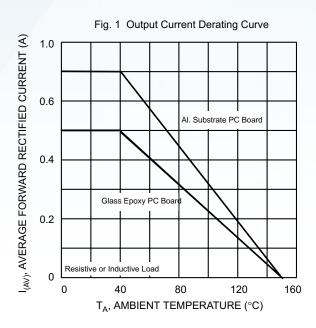
For capacitive load, derate current by 20%

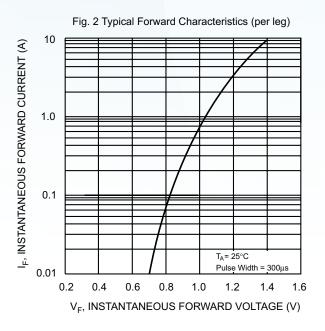
TYPE NUMBER	SYMBOL	MB05M	MB1M	MB2M	MB4M	MB6M	MB8M	MB10M	UNITS
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	VRRM	50	100	200	400	600	800	1000	V
	VRWM								
	VDC								
RMS Reverse Voltage	VRMS	35	70	140	280	420	560	700	V
Average Rectified Output Current (Note 1)@T <sub>A</sub> =40°C (Note 2)@T <sub>A</sub> =40°C	lo	0.5 0.8							Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	Ігѕм	30						Α	
Forward Voltage per element @IF=0.8A	VFM	1.1						V	
Peak Reverse Current @T <sub>A</sub> =25℃ At Rated DC Blocking Voltage @T <sub>A</sub> =125℃	lR	5.0 500						uA	
Typical Junction Capacitance per leg (Note 3)	Сл	13						pF	
Typical Thermal Resistance per leg	Reja	70						°C/W	
	Rejl	20							
Operating and Storage Temperature Range	Т <sub>Ј</sub> ,Тѕтс	-55to+150						$^{\circ}$	

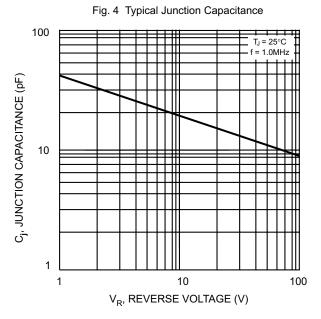
Note:1. Mounted on glass epoxy PC board with 1.3mm<sup>2</sup> solder pad.

- 2. Mounted on aluminum substrate PC board with  $1.3 \mathrm{mm}^2$  solder pad.
- 3. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.











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